

**DECLARATION FOR PATENT APPLICATION  
AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below adjacent to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) which is claimed and for which a patent is sought by way of the application entitled

**"Semiconductor Package And Method Of Making Using Leadframe Having Lead Locks To  
Secure Leads To Encapsulate"**

which (check) ☒ is attached hereto.  
☐ and is amended by the Preliminary Amendment attached hereto.  
☐ was filed on \_\_\_\_\_ as Application Serial No.  
☐ and was amended on \_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date before that of the application(s) of which priority is claimed:

Prior Foreign Applications			Priority Claimed	
Number	Country	Day/Month/Year Filed	Yes	No
98-49887;	Korea	November 20, 1998	<input checked="" type="checkbox"/>	<input type="checkbox"/>
98-52924;	Korea	December 3, 1999	<input checked="" type="checkbox"/>	
98-63126	Korea	December 31, 1998	<input checked="" type="checkbox"/>	

I hereby claim the benefit under Title 35, United States Code, § 119(c) of any United States provisional application(s) listed below:

Provisional Application Number	Filing Date
N/A	

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or PCT international application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information, which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

Application Serial No.	Filing Date	Status (patented, pending, abandoned)
N/A		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith:

Alan H. MacPherson (24,423); Brian D. Ogonowsky (31,988); David W. Heid (25,875); Norman R. Klivans (33,003); Edward C. Kwok (33,938); David E. Steuber (25,557); Michael Shenker (34,250); Stephen A. Terrile (32,946); Peter H. Kang (40,350); Ronald J. Meetin (29,089); Ken John Koestner (33,004); Omkar K. Suryadevara (36,320); David T. Millers (37,396); Kent B. Chambers (38,839); Michael P. Adams (34,763); Robert B. Morrill (43,817); Michael J. Halbert (40,633); Gary J. Edwards (41,008); William B. Tiffany (41,347); James E. Parsons (34,691); Daniel P. Stewart (41,332); Philip W. Woo (39,880); John T. Winburn (26,822); Tom Chen (42,406); Fabio E. Marino (43,339); William W. Holloway (26,182); Don C. Lawrence (31,975); Marc R. Ascolese (42,268); Carmen C. Cook (42,433); David G. Dolezal (41,711); Roberta P. Saxon (43,087); Bernice Chen (42,403); Mary Jo Bertani (42,321); Dale R. Cook (42,434); Sam G. Campbell (42,381); Matthew J. Brigham (44,047); Hugh H. Matsubayashi (43,779); Margaret M. Kelton (44,182); Joseph T. VanLeeuwen (44,383); Patrick D. Benedicto (40,909); T.J. Singh (39,535); Shireen Irani Bacon (40,494); Rory G. Bens (44,028); George Wolken, Jr. (30,441); John A. Odozynski (28,769); Cameron K. Kerrigan (44,826); Barmak S. Sani (45,068); Kenneth C. Brooks (38,393); and Paul E. Lewkowicz (Reg. No. 44,870).

Please address all correspondence and telephone calls to:

James E. Parsons  
Attorney for Applicants  
**SKJERVEN, MORRILL, MacPHERSON, FRANKLIN & FRIEL LLP**  
25 Metro Drive, Suite 700  
San Jose, California 95110-1349

Telephone: 408-453-9200  
Facsimile: 408-453-7979

I declare that all statements made herein of my own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements made herein are made with the knowledge that whoever, in any matter within the jurisdiction of the Patent and Trademark Office, knowingly and willfully falsifies, conceals, or covers up by any trick, scheme, or device a material fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penalties including fine or imprisonment or both as set forth under 18 U.S.C. 1001, and that violations of this paragraph may jeopardize the validity of the application or this document, or the validity or enforceability of any patent, trademark registration, or certificate resulting therefrom.

1.

Full name of sole first joint inventor: Yee, Jae Hak

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: Seoul, KoreaPost Office Address: Kang-Dong Apt. 7-202,  
Amsa 3-Dong,  
Kangdong-gu,  
Seoul, KoreaCitizenship: Korea

2.

Full name of joint inventor: Chung, Young Suk

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: Seoul, KoreaPost Office Address: KyungNam Apt. 7-501,  
Bangbae 3-dong,  
Suhcho-Ku,  
Seoul, KoreaCitizenship: Korea

3.

Full name of joint inventor: Lee, Jae Jin

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: Seoul, KoreaPost Office Address: Mujigae Apt. 207-206,  
Chunggue 2-dong,  
Nowon-ku  
Seoul, KoreaCitizenship: Korea

4.

Full name of joint inventor: Davis, TerryInventor's Signature:  \_\_\_\_\_Date: 11/17/99Residence: Peoria, ArizonaPost Office Address: 8642 W. Via Montoya  
Peoria, Arizona 85382Citizenship: United States

5.

Full name of joint inventor:

Chung, Suk Han

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: Seoul, Korea

Post Office Address: 221-82, Kuui-dong,  
KwangJin-Ku,  
Seoul, Korea

Citizenship: Korea

6.

Full name of joint inventor:

Ku, Jae Hun

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: Seoul, Korea

Post Office Address: YongMa hanshin Apt. 1-710,  
MyunMok 3-dong,  
ChungRang-Ku,  
Seoul, Korea

Citizenship: Korea

7.

Full name of joint inventor:

Kwak, Jae Sung

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: Seoul, Korea

Post Office Address: SinSung Apt. 102-1802,  
Hwikyuing-dong,  
Dongdaemun-Ku,  
Seoul, Korea

Citizenship: Korea

8.

Full name of joint inventor:

Ryu, Sang Hyun

Inventor's Signature: \_\_\_\_\_

Date: \_\_\_\_\_

Residence: Seoul, Korea

Post Office Address: ChoongAng APT, Ga-208,  
Pangbae dong,  
Secho-Gu,,  
Seoul, Korea

Citizenship: Korea

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Please address all correspondence and telephone calls to:

James E. Parsons  
Attorney for Applicants  
**SKJERVEN, MORRILL, MacPHERSON, FRANKLIN & FRIEL LLP**  
25 Metro Drive, Suite 700  
San Jose, California 95110-1349

Telephone: 408-453-9200  
Facsimile: 408-453-7979

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1.

Full name of sole first joint inventor:

Yee, Jae Hak

Inventor's Signature:

01

[Signature]

Date:

Nov. 17, 1999

Residence:

Seoul, Korea

Post Office Address:

Kang-Dong Apt. 7-202,  
Amsa 3-Dong,  
Kangdong-gu,  
Seoul, Korea

Citizenship: Korea

2.

Full name of joint inventor:

Chung, Young Suk

Inventor's Signature:

[Signature]

Date:

Nov. 17, 1999

Residence:

Seoul, Korea

Post Office Address:

KyungNam Apt. 7-501,  
Bangbae 3-dong,  
Suhcho-Ku,  
Seoul, Korea

Citizenship: Korea

3.

Full name of joint inventor:

Lee, Jae Jin

Inventor's Signature:

[Signature]

Date:

Nov. 17, 1999

Residence:

Seoul, Korea

Post Office Address:

Mujigae Apt. 207-206,  
Chunggue 2-dong,  
Nowon-ku  
Seoul, Korea

Citizenship: Korea

4.

Full name of joint inventor:

Davis, Terry

Inventor's Signature:

Date:

Residence:

Peoria, Arizona

Post Office Address:

8642 W. Via Montoya  
Peoria, Arizona 85382

Citizenship: United States

5.

Full name of joint inventor:

Han, Chung Suk

Inventor's Signature: 

Date:

Nov. 17, 1999

Residence:

Seoul, Korea

Post Office Address:


221-82, Kuui-dong,  
KwangJin-Ku,  
Seoul, Korea

Citizenship: Korea

6.

Full name of joint inventor:

Ku, Jae Hun

Inventor's Signature: 

Date:

Nov. 17, 1999

Residence:

Seoul, Korea

Post Office Address:

YongMa hanshin Apt. 1-710,  
MyunMok 3-dong,  
ChungRang-Ku,  
Seoul, Korea

Citizenship: Korea

7.

Full name of joint inventor:

Kwak, Jae Sung

Inventor's Signature: 

Date:

Nov. 17, 1999

Residence:

Seoul, Korea

Post Office Address:

SinSung Apt. 102-1802,  
Hwikyung-dong,  
Dongdaemun-Ku,  
Seoul, Korea

Citizenship: Korea

8.

Full name of joint inventor:

Ryu, Sang Hyun

Inventor's Signature: 

Date:

Nov. 17, 1999

Residence:

Seoul, Korea

Post Office Address:

ChoongAng APT, Ga-208,  
Pangbac dong,  
Seocho-Gu.,  
Seoul, Korea

Citizenship: Korea